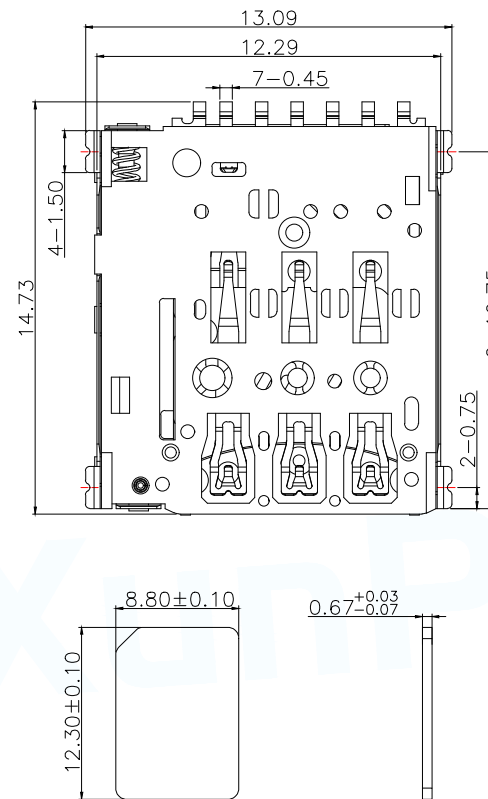
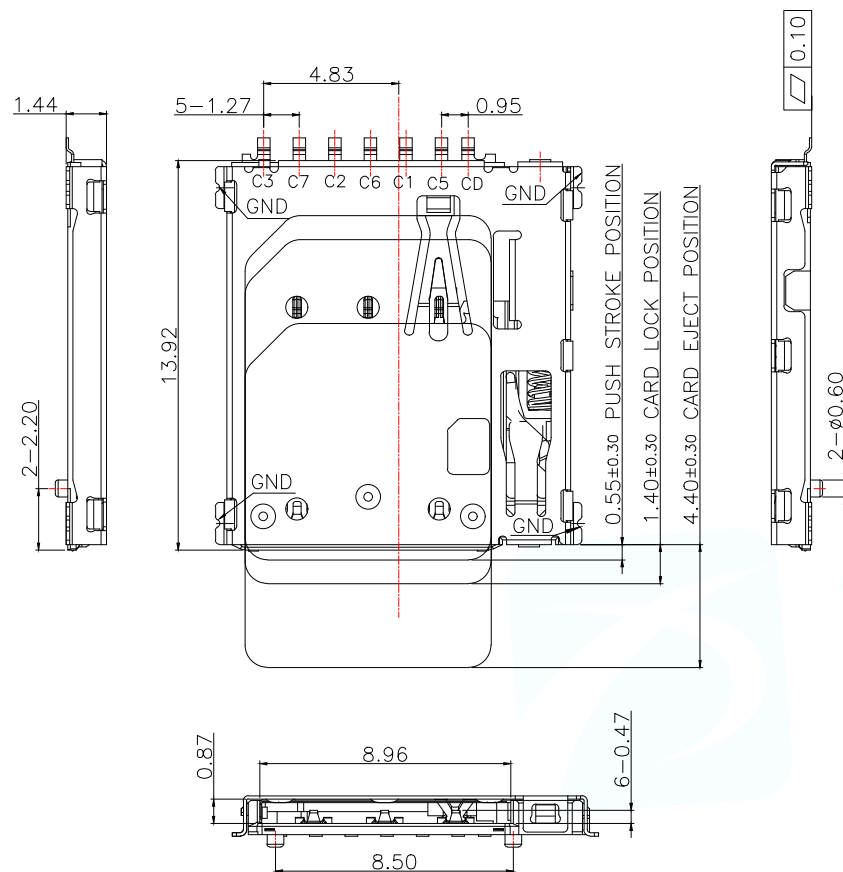
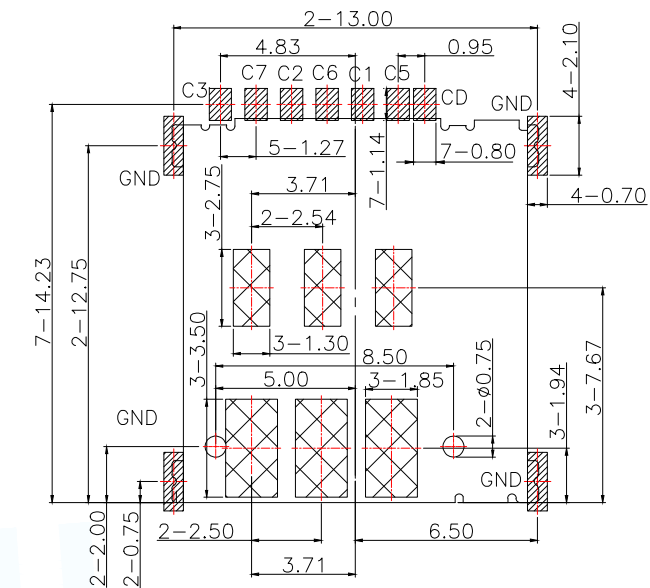




尺寸 2:1



RECOMMENDED PCB LAYOUT

TOLERANCE:±0.05

SMT SOLDER AREA

COPPER RESTRICTED AREA
1.TOUCH AREA OF CONTACT
TIPS NO ELECTRICAL FUNCTION
2.NO FIRST PCB_LAYOUT
CIRCUITS IN THE AREA

Notes:

1.Material:

Housing: High Temperature Thermoplastic

Terminal: Copper Alloy

Shell: Stainless Steel

2.Plating:

Terminal:50u" Ni Underplated Overall

G/F Plated On Contact Area

G/F plated On Solder Area

Shell:30u" Ni Underplated Overall

G.F Plated On Contact Area

And Solder Area

3.Technical Speciality:

Rated Voltage: 0.5A

Current Rating: 0.5A

Insulation Resistance:100mΩ Min

Contact Resistance:100mΩ Max

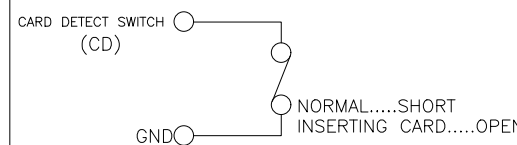
Withstanding Voltage: 500V DC For 1 Minutes

Operating Temperature: -40°C~+75°C

Humidity 80% R.H Max

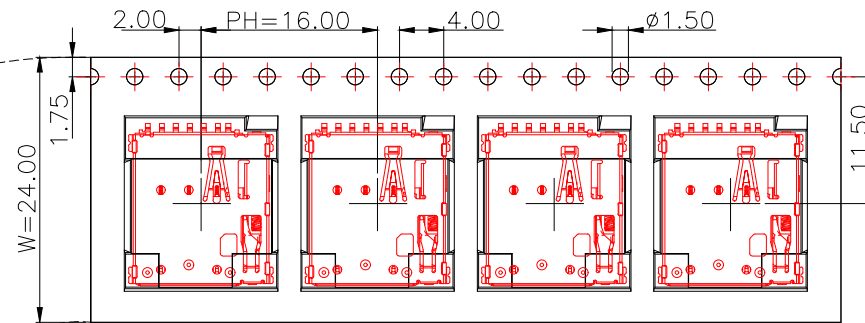
PIN/NO	ASSIGNMENT
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O
CD	DETECT SWITCH

CRICUIT DIAGRAM FOR CARD DETECT SWITCH



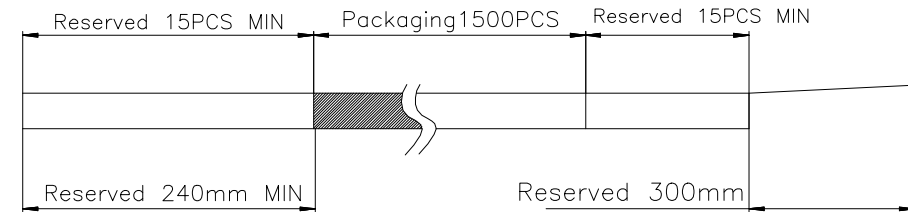
MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES			
DECIMALS:	ANGLES:	TITLE:1.37HPush-PushNano-SIM -SIM 腾飞座	
X.:±0.30	X':±2°	PAR	SMN-317-CCP7
X.X:±0.20		DWN	Lucas
X.XX:±0.10		CHKD	Ethan
		APVD	Jacob
		SCALE:1:1	UNIT:MM
		CUSTOMER COPY	SIZE:A4
			SHEET:1F2
			REV:A

Direction of use

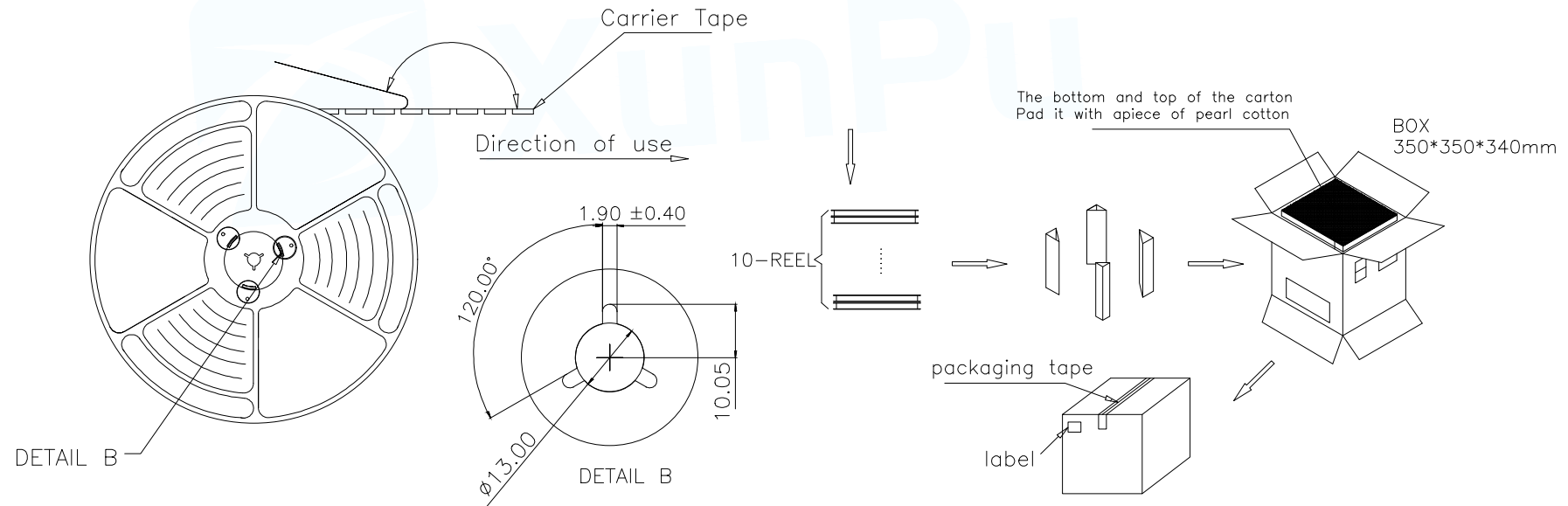


NOTE:

1. Packing quantity per plate: 1500PCS/Plate
2. Loading and packing method



3. Total packaging: 15000PCS/Box



MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co., Ltd		
UNLESS OTHERWISE SPECIFIED TOLERANCES		TITLE: 1.37 H Push-Push Nano-SIM 腾飞插座		
DECIMALS:	ANGLES:		PAR	SMN-317-CCP7
X.: ±0.30	X': ±2°		DWN	Lucas
X.X: ±0.20			CHKD	Ethan
X.XX: ±0.10			APVD	Jacob
CUSTOMER COPY		SCALE 1:1	UNIT: MM	REV: A
		SIZE: A4	SHEET: 2F2	